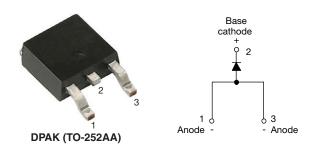
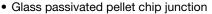


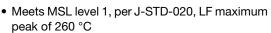
Surface Mount Fast Soft Recovery Rectifier Diode, 8 A



| PRIMARY CHARACTERISTICS | | | | | | |
|----------------------------------|-----------------|--|--|--|--|--|
| I _{F(AV)} | 8 A | | | | | |
| V _R | 600 V | | | | | |
| V _F at I _F | 1.2 V | | | | | |
| I _{FSM} | 150 A | | | | | |
| t _{rr} | 55 ns | | | | | |
| T _J max. | 150 °C | | | | | |
| Snap factor | 0.5 | | | | | |
| Package | DPAK (TO-252AA) | | | | | |
| Circuit configuration | Single | | | | | |

FEATURES







- AEC-Q101 qualified
- Meets JESD 201 class 2 whisker test
- Flexible solution for reliable AC power rectification
- High surge, low V_F rugged blocking diode for DC charging stations
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- On-board and off-board EV / HEV battery chargers
- Renewable energy inverters

DESCRIPTION

The VS-8EWF06SLHM3 fast soft recovery rectifier series has been optimized for combined short reverse recovery time, low forward voltage drop and low leakage current.

The glass passivation ensures stable reliable operation in the most severe temperature and power cycling conditions.

| MAJOR RATINGS AND CHARACTERISTICS | | | | | | | | |
|-------------------------------------|-----------------------------|-------------|----|--|--|--|--|--|
| SYMBOL CHARACTERISTICS VALUES UNITS | | | | | | | | |
| I _{F(AV)} | Sinusoidal waveform | 8 | Α | | | | | |
| V_{RRM} | | 600 | V | | | | | |
| I _{FSM} | | 150 | A | | | | | |
| V _F | 8 A, T _J = 25 °C | 1.2 | V | | | | | |
| t _{rr} | 1 A, 100 A/μs | 55 | ns | | | | | |
| TJ | Range | -40 to +150 | °C | | | | | |

| VOLTAGE RATINGS | | | |
|-----------------|---|--|-------------------------------------|
| PART NUMBER | V _{RRM} , MAXIMUM PEAK REVERSE VOLTAGE V | V _{RSM} , MAXIMUM NON-REPETITIVE PEAK REVERSE VOLTAGE V | I _{RRM} AT 150 °C mA |
| VS-8EWF06SLHM3 | 600 | 700 | 3 |

| ABSOLUTE MAXIMUM RATINGS | | | | | | | |
|--------------------------------------|--|--|--------|------------------|--|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS | | | |
| Maximum average forward current | I _{F(AV)} | T _C = 96 °C, 180° conduction half sine wave | 8 | | | | |
| Maximum peak one cycle | | 10 ms sine pulse, rated V _{RRM} applied 125 | | Α | | | |
| non-repetitive surge current | IFSM | 10 ms sine pulse, no voltage reapplied | 150 | | | | |
| Maximum I ² t for fusing | m l ² t for fusina l ² t | 10 ms sine pulse, rated V _{RRM} applied | 78 | A ² s | | | |
| Maximum i-t for fusing | I-t | 10 ms sine pulse, no voltage reapplied | 110 | A-S | | | |
| Maximum I ² √t for fusing | I ² √t | t = 0.1 ms to 10 ms, no voltage reapplied | 1100 | A²√s | | | |



| ELECTRICAL SPECIFICATIONS | | | | | | | |
|---------------------------------|-------------------------------------|-----------------------------|---------------------------|-----|------|--|--|
| PARAMETER | SYMBOL TEST CONDITIONS VALUES UNITS | | | | | | |
| Maximum forward voltage drop | V_{FM} | 8 A, T _J = 25 °C | 1.2 | V | | | |
| Forward slope resistance | r _t | T _ 150 °C | T _J = 150 °C | | | | |
| Threshold voltage | V _{F(TO)} | 1j = 150 C | | | | | |
| Maximum reverse leakage current | 1 | T _J = 25 °C | V_{B} = rated V_{BBM} | 0.1 | mA | | |
| Maximum reverse leakage current | IRM | T _J = 150 °C | VR = rated VRRM | 3 | IIIA | | |

| RECOVERY CHARACTERISTICS | | | | | | |
|--------------------------|-----------------|---|--------|-------|-------------------------------|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS | | |
| Reverse recovery time | t _{rr} | I _F at 1 A _{pk} 100 A/µs T _J = 25 °C | 55 | ns | I _{FM} | |
| | | I⊨ at 8 A | 200 | | t _a t _b | |
| Reverse recovery current | I _{rr} | I _F at 8 A _{pk} 25 A/µs | 2.6 | Α | di | |
| Reverse recovery charge | Q _{rr} | T _J = 25 °C | 0.25 | μC | at I _{rr} | |
| Snap factor | S | | 0.5 | | | |

| THERMAL - MECHANICAL SPECIFICATIONS | | | | | | |
|---|-----------------------------------|----------------------------|-------------|-------|--|--|
| PARAMETER | SYMBOL | TEST CONDITIONS | VALUES | UNITS | | |
| Maximum junction and storage temperature range | T _J , T _{Stg} | | -40 to +150 | °C | | |
| Maximum thermal resistance, junction to case | R _{thJC} | DC operation | 2.5 | °C/W | | |
| Typical thermal resistance, junction to ambient (PCB mount) | R _{thJA} ⁽¹⁾ | | 50 | C/VV | | |
| Approximate weight | | | 1 | g | | |
| Approximate weight | | | 0.03 | OZ. | | |
| Marking device | | Case style DPAK (TO-252AA) | 8EWF0 | D6SH | | |

Note

⁽¹⁾ When mounted on 1" square (650 mm²) PCB of FR-4 or G-10 material 4 oz. (140 µm) copper 40 °C/W

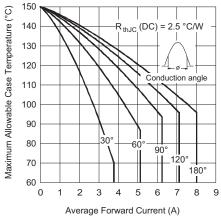


Fig. 1 - Current Rating Characteristics

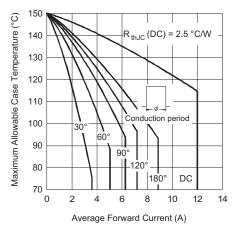


Fig. 2 - Current Rating Characteristics

www.vishay.com

Vishay Semiconductors

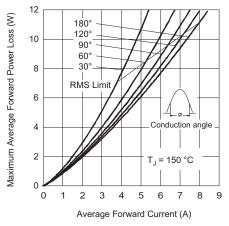


Fig. 3 - Forward Power Loss Characteristics

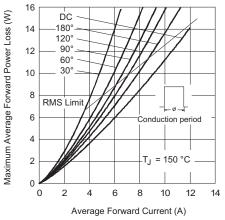


Fig. 4 - Forward Power Loss Characteristics

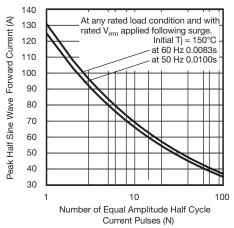


Fig. 5 - Maximum Non-Repetitive Surge Current

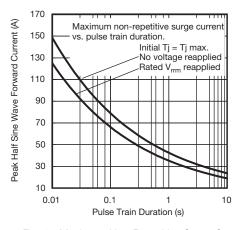


Fig. 6 - Maximum Non-Repetitive Surge Current

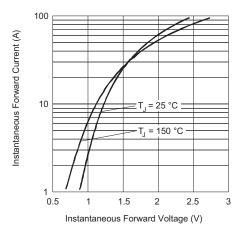


Fig. 7 - Forward Voltage Drop Characteristics

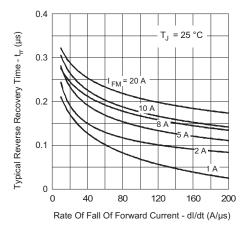


Fig. 8 - Recovery Time Characteristics, T_J = 25 °C

www.vishay.com Vishay Semiconductors

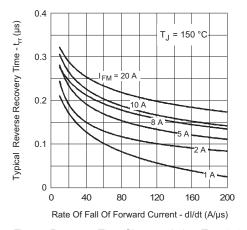


Fig. 9 - Recovery Time Characteristics, T_J = 150 °C

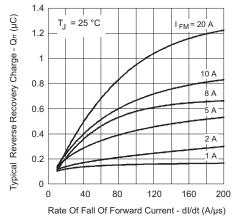


Fig. 10 - Recovery Charge Characteristics, $T_J = 25$ °C

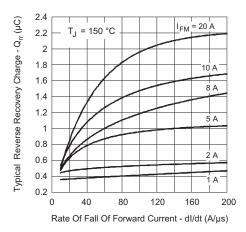


Fig. 11 - Recovery Charge Characteristics, T_J = 150 °C

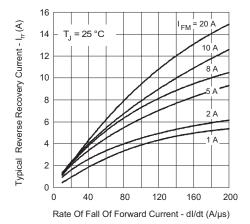


Fig. 12 - Recovery Current Characteristics, $T_J = 25\ ^{\circ}\text{C}$

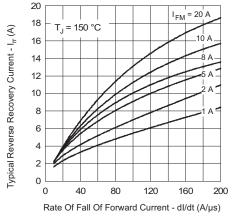


Fig. 13 - Recovery Current Characteristics, T_J = 150 °C

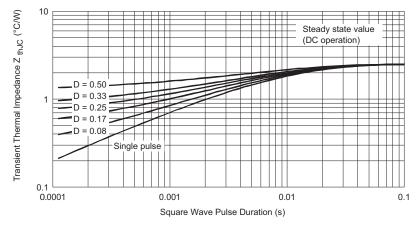


Fig. 14 - Thermal Impedance Z_{thJC} Characteristics

ORDERING INFORMATION TABLE

Device code VS-8 Ε W F 06 S L Н **M3** (2) 3) (5) (6) (7)(8) (10)4 Vishay Semiconductors product Current rating (8 = 8 A) Circuit configuration: E = single Package: W = DPAK (TO-252AA)5 Type of silicon: F = fast soft recovery rectifier Voltage code x 100 = V_{RRM} 06 = 600 V

| 8 | - | L = tape and reel (left oriented), for different orientation contact factory |
|---|---|--|
| _ | | |

9 - H = AEC-Q101 qualified

S = surface mountable

10 - Environmental digit:

M3 = halogen-free, RoHS-compliant, and terminations lead (Pb)-free

| ORDERING INFORMATION (Example) | | | | | | | |
|--------------------------------|------------------|------------------------|-----------------------|--|--|--|--|
| PREFERRED P/N | QUANTITY PER T/R | MINIMUM ORDER QUANTITY | PACKAGING DESCRIPTION | | | | |
| VS-8EWF06SLHM3 | 3000 | 3000 | 13" diameter reel | | | | |

| LINKS TO RELATED DOCUMENTS | | | | |
|----------------------------|--------------------------|--|--|--|
| Dimensions | www.vishay.com/doc?95519 | | | |
| Part marking information | www.vishay.com/doc?95518 | | | |
| Packaging information | www.vishay.com/doc?96495 | | | |



DPAK (TO-252AA)



| SYMBOL | MILLIN | IETERS | INC | NOTES | |
|----------|--------|--------|-------|-------|-------|
| STINIBUL | MIN. | MAX. | MIN. | MAX. | NOTES |
| Α | 2.18 | 2.39 | 0.086 | 0.094 | |
| A1 | 1 | 0.13 | - | 0.005 | |
| b | 0.64 | 0.89 | 0.025 | 0.035 | |
| b2 | 0.76 | 1.14 | 0.030 | 0.045 | |
| b3 | 4.95 | 5.46 | 0.195 | 0.215 | 3 |
| С | 0.46 | 0.61 | 0.018 | 0.024 | |
| c2 | 0.46 | 0.89 | 0.018 | 0.035 | |
| D | 5.97 | 6.22 | 0.235 | 0.245 | 5 |
| D1 | 4.93 | - | 0.194 | - | 3 |
| Е | 6.35 | 6.73 | 0.250 | 0.265 | 5 |
| E1 | 4.32 | - | 0.170 | - | 3 |

| SYMBOL | MROI MILLIMETERS INCHES | | NOTES | | |
|----------|-------------------------|-------|-------|-------|-------|
| STIVIBUL | MIN. | MAX. | MIN. | MAX. | NOTES |
| е | 2.29 | BSC | 0.090 | BSC | |
| Н | 9.40 | 10.41 | 0.370 | 0.410 | |
| L | 1.40 | 1.78 | 0.055 | 0.070 | |
| L1 | 2.74 BSC | | 0.108 | REF. | |
| L2 | 0.51 | BSC | 0.020 | BSC | |
| L3 | 0.89 | 1.27 | 0.035 | 0.050 | 3 |
| L4 | - | 1.02 | - | 0.040 | |
| L5 | 1.14 | 1.52 | 0.045 | 0.060 | 2 |
| | • | • | | • | |

Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Dimensions D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (5) Outline conforms to JEDEC® outline TO-252AA, except for D1 dimension



Legal Disclaimer Notice

Vishay

Disclaimer

ALL PRODUCT, PRODUCT SPECIFICATIONS AND DATA ARE SUBJECT TO CHANGE WITHOUT NOTICE TO IMPROVE RELIABILITY, FUNCTION OR DESIGN OR OTHERWISE.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained in any datasheet or in any other disclosure relating to any product.

Vishay makes no warranty, representation or guarantee regarding the suitability of the products for any particular purpose or the continuing production of any product. To the maximum extent permitted by applicable law, Vishay disclaims (i) any and all liability arising out of the application or use of any product, (ii) any and all liability, including without limitation special, consequential or incidental damages, and (iii) any and all implied warranties, including warranties of fitness for particular purpose, non-infringement and merchantability.

Statements regarding the suitability of products for certain types of applications are based on Vishay's knowledge of typical requirements that are often placed on Vishay products in generic applications. Such statements are not binding statements about the suitability of products for a particular application. It is the customer's responsibility to validate that a particular product with the properties described in the product specification is suitable for use in a particular application. Parameters provided in datasheets and / or specifications may vary in different applications and performance may vary over time. All operating parameters, including typical parameters, must be validated for each customer application by the customer's technical experts. Product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein.

Hyperlinks included in this datasheet may direct users to third-party websites. These links are provided as a convenience and for informational purposes only. Inclusion of these hyperlinks does not constitute an endorsement or an approval by Vishay of any of the products, services or opinions of the corporation, organization or individual associated with the third-party website. Vishay disclaims any and all liability and bears no responsibility for the accuracy, legality or content of the third-party website or for that of subsequent links.

Except as expressly indicated in writing, Vishay products are not designed for use in medical, life-saving, or life-sustaining applications or for any other application in which the failure of the Vishay product could result in personal injury or death. Customers using or selling Vishay products not expressly indicated for use in such applications do so at their own risk. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay. Product names and markings noted herein may be trademarks of their respective owners.